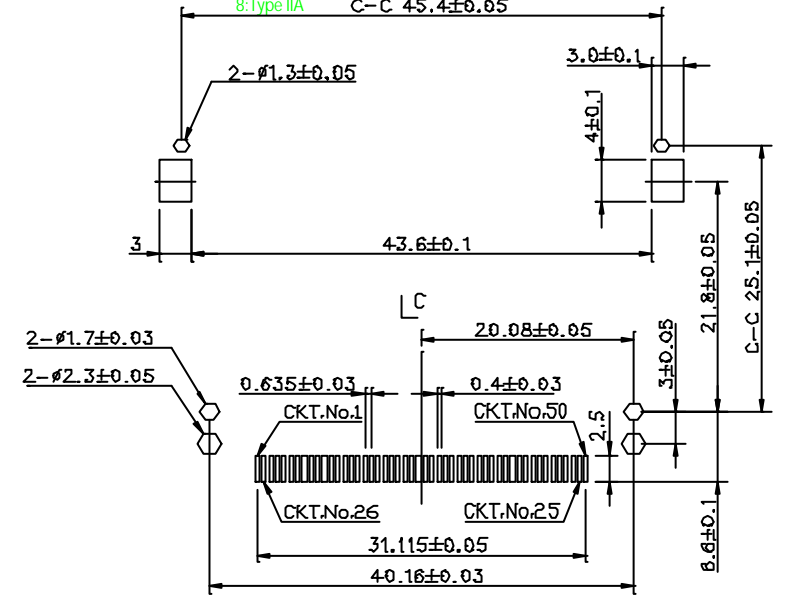


NOTES:
 1. MATERIAL:
 INSULATOR: GLASS REINFORCED LCP UL94V-0
 CONTACT: BRASS ALLOY
 MOUNT EAR: BRASS; TIN PLATED OVERALL
 2. CONTACT PLATING:
 CONTACT AREA: GOLD PLATING OVER 40u" NICKEL
 SOLDER TAIL AREA: 100u" TIN PLATING OVER 40u" NICKEL

更改 REV	設變內容 MODIFICATION	日期 DATE	修改 DRAW

ORDER INFORMATION:

Header Type:	Stand Off:	Contact Plating:	Attachment:
0: Type IA	9: Type IIR	0: 0mm	1: Gold Flush
1: Type IAR	A: Type IIB	1: 1.64mm	2: 5u" Gold Sel.
2: Type IB	B: Type IIBR	2: 2.20mm	3: 10u" Gold Sel.
3: Type IBR	C: Type IE	3: 1.70mm	4: 15u" Gold Sel.
4: Type IC	D: Type IF		
5: Type ICR	E: Type IGO		
6: Type ID	F: Type IGOR		
7: Type IDR	G: Type IIBDRS		
8: Type IIA	C-C 45.4±0.05		



RECOMMENDED P.C.B. LAYOUT

DIMENSION IN mm [Inch]			 康茂股份有限公司 COMMA ELECTRONIC INC	
TOLERANCE UNLESS OTHERWISE SPECIFIED			名稱 TITLE	CUSTOMER DRAWING
.X±0.3	X: ± 3'	審核 APPROVE	CF Card Header SMT 50P Type II (BDRS)	
.XX±0.20	.X ± 0.5'	核對 CHECK	案號 FILE NO. 60135020	圖號 DWG NO. CFS1.27-G020
.XXX±0.100	.XX ± 0.25'	製圖 DRAW	圖紙 SIZE A4	角法 PROJ. 日期 DATE 10/17/02 比例 SCALE N.S.T. 更改 REV A